

VSTA065R38ANA

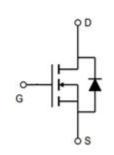
Datasheet

VMD5EMI



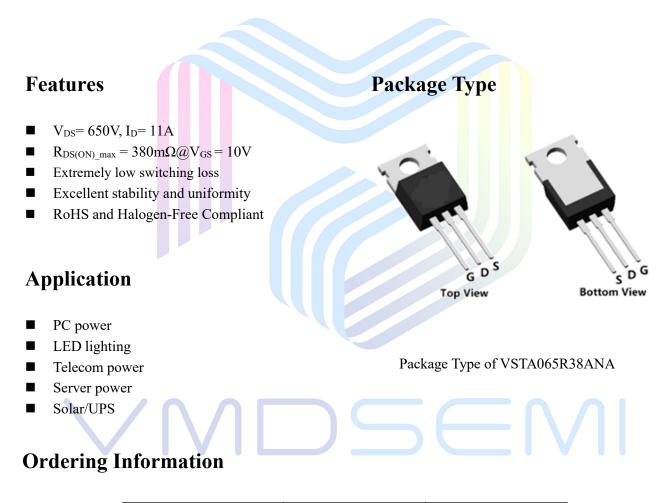
General Description

V _{(BR)DSS}	R _{DS(ON)_max}	ID
650V	380mΩ@10V	11A



Symbol

Symbol of VSTA065R38ANA



Product Name	Package	Marking
VSTA065R38ANA	TO-220	STA065R38ANA

VSTA065R38ANA



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Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	V _{DS}	650	V	
Gate-Source Voltage	V _{GS}	±30	V	
Continuous Drain Current ^{Note 1} , T _C =25°C	ID	11	A	
Pulsed Drain Current ^{Note 2} , T _C =25°C	I _{D, pulse}	33	A	
Continuous Diode Forward Current ^{Note 1} , T _C =25°C	Is	11	A	
Diode Pulsed Current ^{Note 2} , T _C =25°C	I _{S, pulse}	33	A	
Max Power Dissipation Note 3, T _C =25°C	PD	110	W	
Avalanche Current, Single Pulse Note 4	I _{AS}	2.5	A	
Avalanche Energy, Single Pulse ^{Note4}	Eas	250	mJ	
MOSFET dv/dt ruggedness, V _{DS} =0~480V	dv/dt	50	V/ns	
Reverse diode dv/dt, $V_{DS}=0\sim480$ V, $I_{SD} \le I_D$	dv/dt	15	V/ns	
Operation and storage temperature	T _J ,T _{STG}	- <mark>5</mark> 5 to 150	°C	

Thermal Resistance

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	R _{θJC}		1.14		°C/W
Thermal Resistance, Junction-to-Ambient Note5	R _{0JA}		62		-C/w

Notes:

Note1: Calculated continuous current based on maximum allowable junction temperature.

Note2: Pulse width limited by safe operating area.

Note3: Based on max. junction temperature, using junction-case thermal resistance.

Note4: V_{DD}=100V,V_{GS}=10V, L=80mH, starting T_A=25 °C.

Note5: When mounted on 1 inch square copper board, t \leq 10sec. The value in any given application depends on the user's specific board design.



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Electrical Characteristics(T_A= 25 °C, unless otherwise specified)

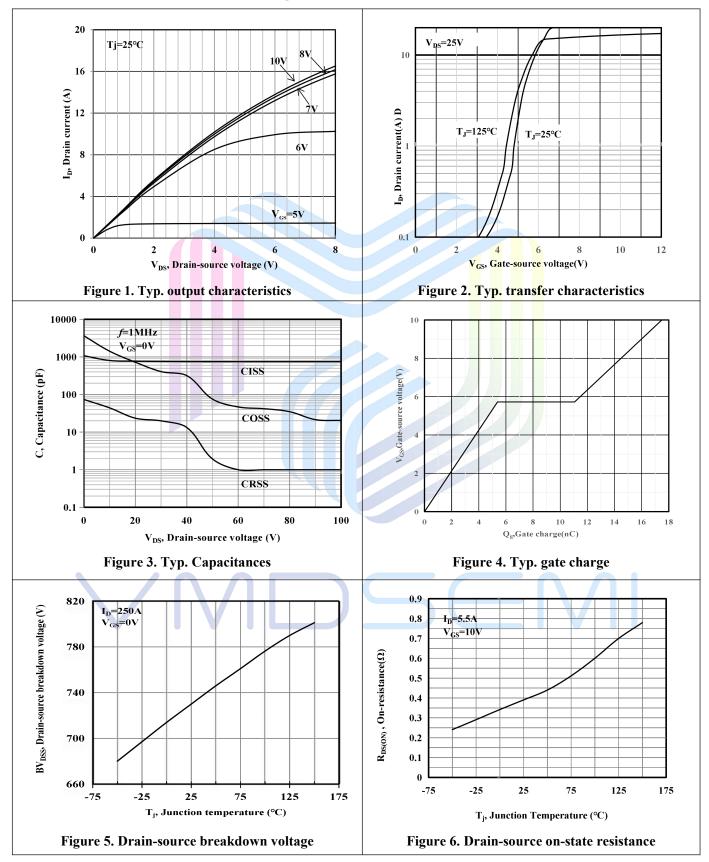
Parameter		Symbol	Test Conditions	Min	Тур	Max	Uni
Statistic Characteristics							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250uA	650			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =650V, V _{GS} =0V			1	uA
Gate-Source Leakage Current	Forward	I _{GSSF}	$V_{GS}=30V, V_{DS}=0V$			100	nA
	Reverse	I _{GSSR}	V_{GS} =-30V, V_{DS} =0V			-100	
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	2.9		3.9	V
Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =5.5A		350	380	mΩ
Gate Resistance		R _G	F=1MHz, Open Drain		5.1		Ω
Dynamic Characteristics							
Input Capacitance		C _{iss}	N FOULL ON		752		pF
Output Capacitance		Coss	V_{DS} =50V, V_{GS} =0V,		75		pF
Reverse Transfer Capacitance		C _{rss}	f=1MHz		1.9		pF
Turn-on Delay Time		t _{d(on)}			10.9		
Rise Time		tr	$V_{DS}=400V, I_D=6A, R_G=2\Omega, V_{GS}=10V$		5.6		ns
Turn-off Delay Time		t _{d(off)}			32.6		
Fall Time		t _f			7.1		
Gate Charge Characteristics							
Gate to Source Charge		Q _{gs}			4.95		
Gate to Drain Charge		Q _{gd}	V _{DS} =400V, I _D =6A,		6.20		nC
Gate Charge Total		Qg	$V_{GS}=0$ to 10V		17.52		
Gate Plateau Voltage		V _{Plateau}			5.72		V
Reverse Diode Characteristics							
Drain-Source Diode Forward Voltage		V _{SD}	$V_{GS}=0V, I_S=1A$		0.74		V
Reverse Recovery Time		t _{rr}	- V _R =400V, I _S =6A, di/dt=100A/us		200.5		ns
Reverse Recovery Charge		Qrr			1.86		uC
Peak Reverse Recovery Current		I _{rrm}	$\int dt/dt = 100 \text{ A}/\text{us}$		16.3		Α



$380m\Omega$, 650V, N-Channel Power MOSFET

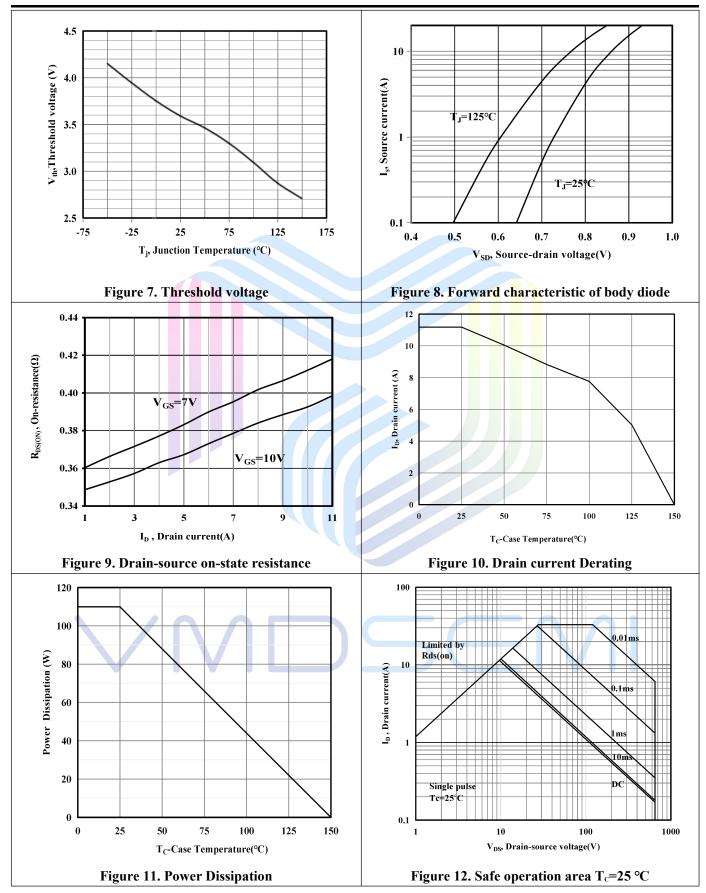
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Electrical Characteristics Diagrams



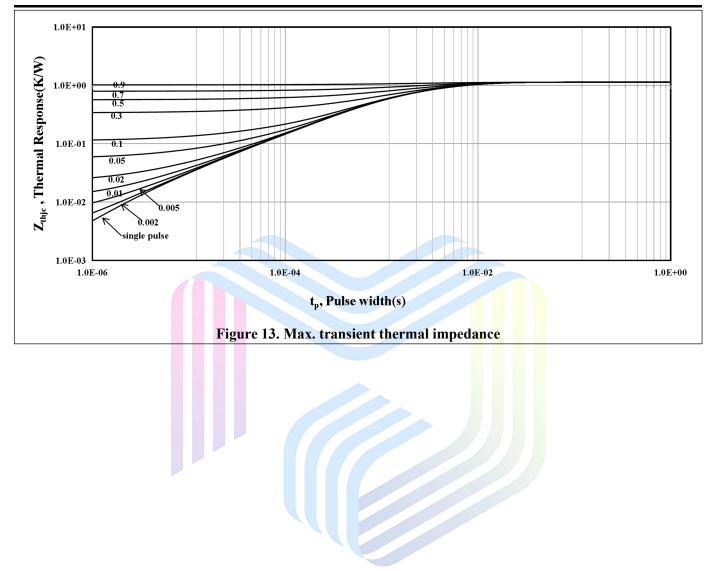


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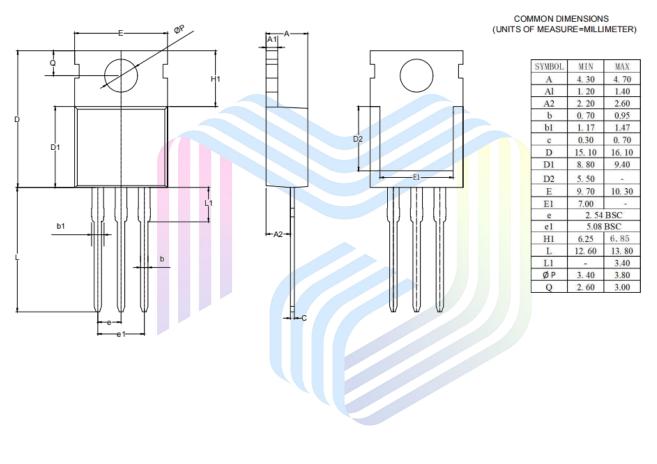
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Mechanical Dimensions

TO-220 Package Information



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